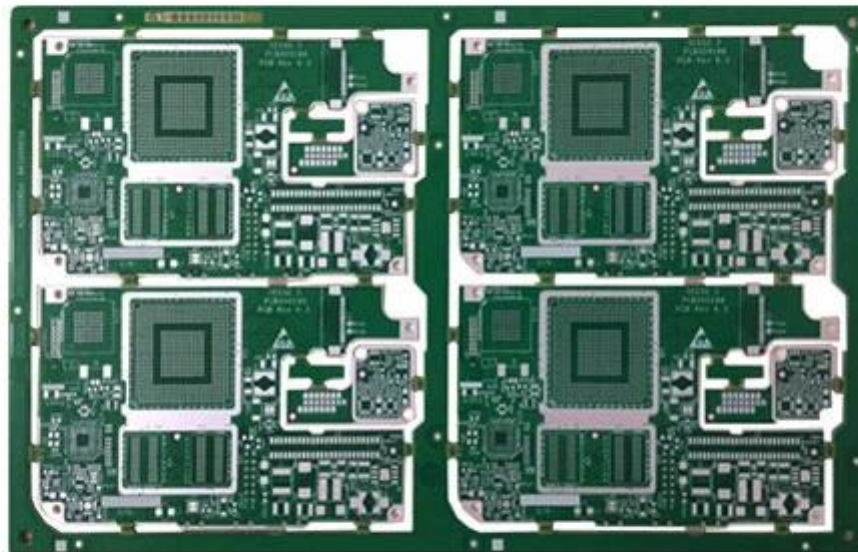


板厚公差: .025 AVG, .020 MIN .. 板厚公差: ± 0.005
表面处理: ENIG, 阻焊: ± 7%, 板厚公差

板厚公差: ± 0.005, 25 PCS / bag, 板厚公差: ± 0.005, 板厚公差: ± 0.005

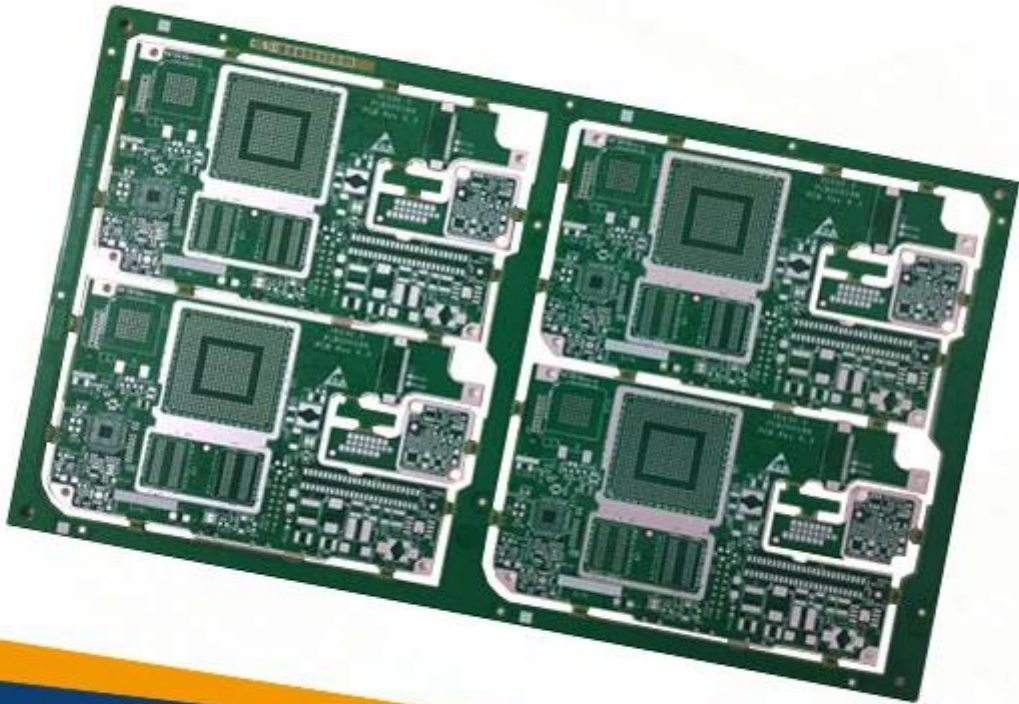
板厚公差

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